

Sizing and Margin Methodology for Dual-Layer Thermal Protection Systems

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Dual-Layer TPS Material (HEEET)



- Increased mass efficiency of dual-layer materials allows mission designers to select shallow entry trajectories
 - Integrate a top layer with good recession performance with a bottom layer with good insulation performance
- NASA is maturing a dual-layer 3D-woven TPS called HEEET
 - Top layer made of densely woven carbon fibers (**Recession Layer, RL**)
 - Bottom layer made of carbon and phenolic yarns (Insulation Layer, IL)

Need to develop a sizing process

- Project has developed and validated a onedimensional thermal response model based on material property and arcjet testing
- Adapt the conventional NASA ablator sizing process for application to dual-layer materials
- Weaving width limitation drives need for a tiled system
 - This talk focuses on acreage material sizing
 - Full sizing process has been developed and accounts for the gap filler thermal response uncertainties





TPS Sizing and Modelling Uncertainties



- TPS thickness is sized to satisfy certain mission-dependent design constraints
 - Typically for single-layer materials, the constraint is a not-to-exceed bondline temperature driven by adhesive or structure temperature limits
- There are uncertainties associated with models used in TPS sizing process
 - Trajectory dispersions
 - Uncertainties in aerothermal environments (ground-to-flight traceability)
 - Uncertainties in thermal response modelling (properties, models, initial conditions)
- TPS sizing process must include margins that protect against uncertainties in modelling
 - Margins can be applied to initial conditions, boundary conditions, design constraints or sized thickness
 - Margins are selected based on testing, uncertainty propagation or engineering judgement



Conventional NASA Ablator Sizing Process



- Aerothermal environments are computed on the bounding trajectory (typically max heat load)
- At each sizing location, TPS thickness is sized along three branches and combined in a root-sum-square (RSS) process
 - Zero margin: apply nominal environments and size thickness to bondline temperature limit
 - Material margin: account for material modelling uncertainties (typically done by reducing bondline temperature by a margin informed through Monte Carlo analysis)
 - Aerothermal margin: account for uncertainty in aerothermal environments (multiplying factors)
- Other considerations: manufacturing tolerance, factor of safety, recession margin



Dual-Layer Sizing Nuances



- New constraint at the interface between two layers
 - HEEET insulation layer should not be exposed to flow
 - Arcjet testing scope limited to RL
- RL is sized to be equal to the predicted recession; IL is sized to bondline temperature limit
 - Material margin must be considered for both interfaces



- Current HEEET implementation requires uniform TPS thickness for both layers
 - Need to find max required thickness for each layer across all body points and trajectories
- Max thickness for each layer may occur at different body points and trajectories
 - Higher ablation leads to lower heat conduction into TPS

Dual-Layer Sizing Nuances



- Sizing RL and IL independently and then stacking max RL thickness from one location on max IL thickness from another location is not mass efficient
 - Excess RL at some locations can serve as insulation
- More mass efficient to size IL after fixing RL to max sized thickness across all locations



Dual-Layer Sizing Process



- Proposed sizing process takes advantage of the nonessential portion of RL thickness at locations that don't drive RL sizing
 - RL-alone calculation to determine recession for each sizing case; fix RL thickness to maximum RSSed recession across all cases (body points, bounding trajectories)
 - IL is sized for all sizing cases to bondline temperature limit using the fixed RL thickness; Final IL thickness is the maximum thickness across all cases



Reference Missions



Venus Lander

- 2010 NASA study VITaL (shallow)
- 45-deg spherecone
- D=3.5m, M_E= 2750kg
- V_E = 11.3 km/s, V_E = -9 deg
- Aeroheating simulations by Grant Palmer
- 9 sizing cases (9 body points, 1 trajectory)
- Highlights location impact on sizing

Saturn Probe

- NF-4 proposal (SPRITE), PI: Amy Simon (GSFC), managed by JPL
- 45-deg Spherecone, 1.25m diameter, 447kg entry mass
- V_E = 26.9 km/s, Y_E = -14 deg
- Aeroheating simulations by Dinesh Prabhu
- Total of 8 sizing cases (4 body points for max heat rate and load trajectories)
- Highlights trajectory impact on sizing



Sizing for Venus Reference Mission



- Sizing done at 9 locations on the heatshield
 - Figure on left: RL and IL sized independently
 - Figure on right: RL sized first; then IL sized while for fixed RL thickness
- Taking advantage of the nonessential portion of RL thickness at locations that don't drive RL sizing provides mass benefits
 - 62% reduction in IL thickness, 19% reduction in areal mass



Sizing for Saturn Reference Mission



- Sizing done at four locations on the heatshield and for two bounding trajectories, Max Heat Rate (MHR) and Max Heat Load (MHL)
- Maximum RL thickness occurs at shoulder for max heat rate trajectory
- Maximum IL thickness occurs at stagnation point for max heat load trajectory
- Independent RL and IL sizing would have resulted in 21% increase in IL thickness and 9% increase in areal mass



Summary and Conclusions



- Sizing based on only stagnation point environments in early mission phases may not bound required thickness
 - Both for single-layer and dual-layer materials
 - The size of impact is likely larger for dual-layer materials if each layer has to be constant thickness across the heatshield
 - In applications where off-stagnation environments are suspected to be higher, utilizing CFD simulations early in the design is highly recommended
- Proposed sizing methodology takes advantage of the insulation properties of the excess recession layer at locations that don't drive RL thickness
- Allowing the insulation layer to be exposed to flow will provide more flexibility in TPS sizing and design
 - Requires arcjet testing of insulation layer to establish its max capability
 - Sizing process needs to be modified for a different interface constraint (ex. limit on combined aerothermal environment experienced by insulation layer)
- Allowing varying TPS thickness across the heatshield will offer mass benefits
 - Manufacturing challenges should not be underestimated

Backup



Complete HEEET Sizing Process (Including Gap Filler and Manufacturing Considerations)





* Each case represents a single location on the heatshield for a single trajectory. To capture the maximum required thickness for each layer, calculations are performed for bounding trajectories and at multiple locations on the heatshield.

[•] Factor of 1.1 is inserted on branch 2 in lieu of a bond line margin.

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